

Asia's Leading Electronics Technology Exhibition

NEPCON JAPAN

Exhibition for following technologies

SMT

Components

PCB

Testing

IC & Sensor Packaging

Fine Process Technology

Power Device & Module

Osaka Show

Dates:
May 13(Wed) – 15(Fri), 2026

Venue:
INTEX Osaka, Japan

Tokyo Show -September-

Dates:
Sep. 9(Wed) – 11(Fri), 2026

Venue:
Makuhari Messe, Japan

Nagoya Show

Dates:
Nov. 25(Wed) – 27(Fri), 2026

Venue:
AICHI SKY EXPO, Japan

Tokyo Show -February-

Dates:
Feb. 17(Wed) – 19(Fri), 2027

Venue:
Tokyo Big Sight, Japan

Organised by: RX Japan Ltd.

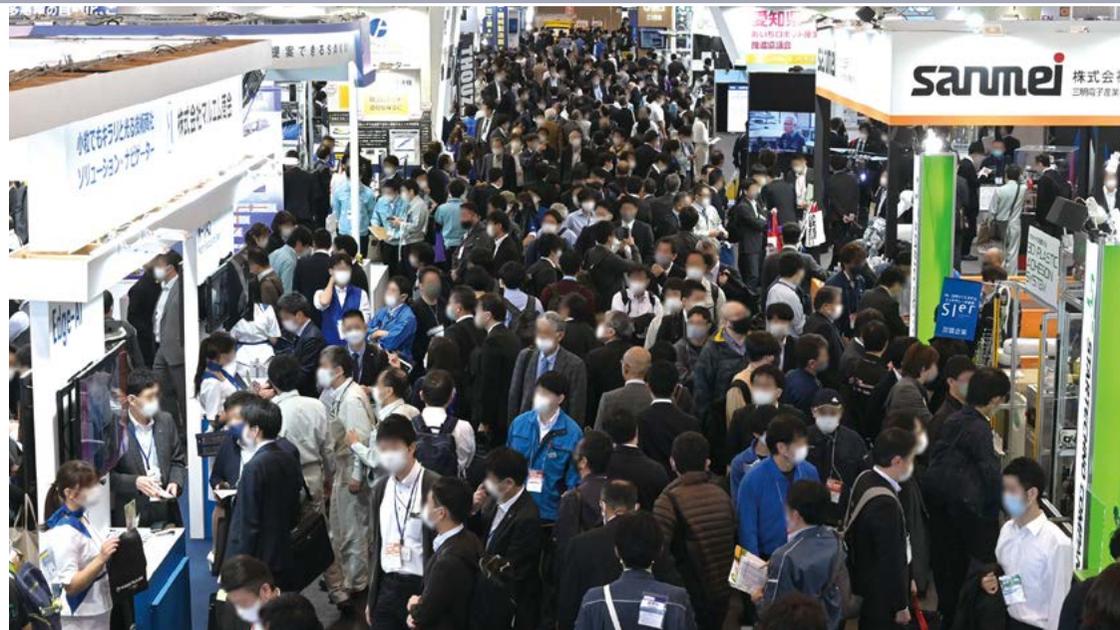
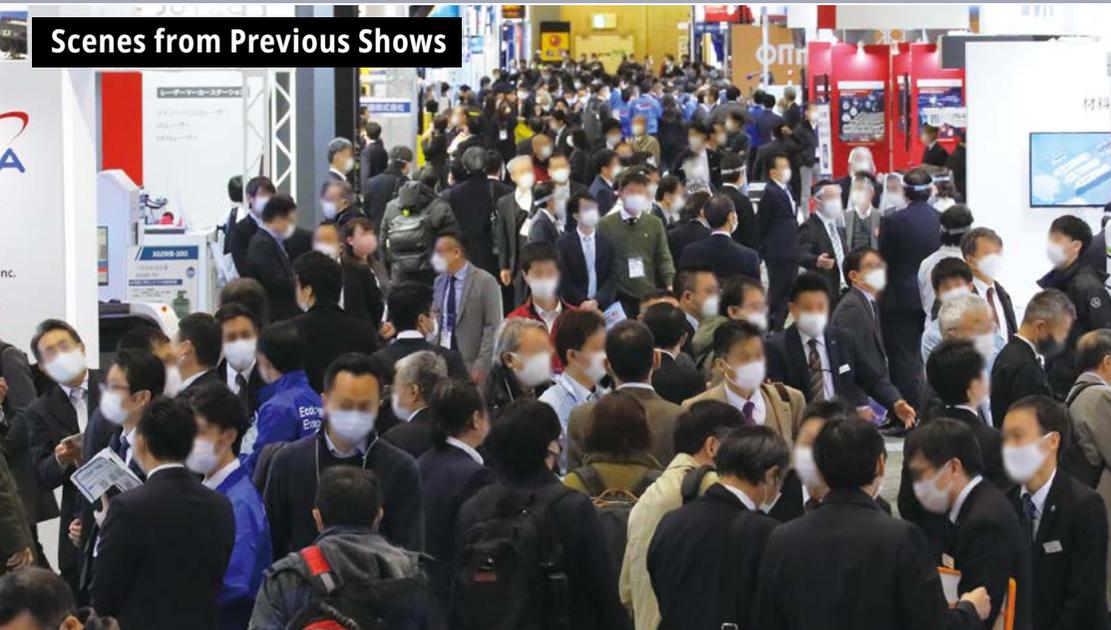
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Asia's Leading Electronics Technology Exhibition

Scenes from Previous Shows



B2B Exhibition for R&D and Manufacturing Technologies

Exhibitors

Manufacturers and trading companies of the following fields:

- SMT
- Testing Technologies
- Technologies for IC & Sensor Packaging
- Electronic Components/ Materials
- Printed Circuit Boards
- Fine Process Technologies
- Power Device & Module Technologies

etc.

Business Meetings

- ◆ New Product/ Technology Introduction
- ◆ Technical Consultation
- ◆ New Partnership Arrangement
- ◆ Price/Delivery Date Arrangement



Visitors

Engineers of the following manufacturers:

- Electronic Devices
- Semiconductors/ Electronic Components
- Automobiles, Automotive Components
- Medical Equipment
- Robots, FA Equipment

- New Entrants to Electronic Industry

etc.

The Show Consists of 7 Specialised Fairs

<Exhibit Profile>

SMT

- Mounters
- Taping
- Printing Machines/Masks
- Clean/ESD Protection
- Soldering Machines

etc.



Testing Technology

- Vision Inspection
- Measurements, Inspections, Analysis
- Non Destructive Inspection Equipment
- Testers

etc.



Packaging Technology

- Materials
- Components
- Semiconductor Device Inspection Equipment
- Assembly/Testing Equipment
- Plating/Etching Materials

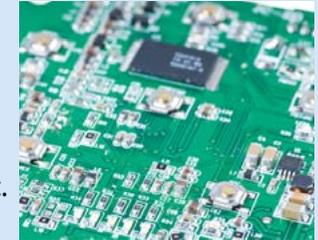
etc.



PCBs

- Rigid PCBs
- Multi-layered PCBs
- Semiconductor Packaging PCBs
- Flexible PCBs
- Optical PCBs

etc.



Electronic Components & Materials

- Terminal Blocks
- Sensors
- Materials for Mounted Circuit
- Connectors & Cables
- Switches, Registers

etc.



Fine Process Technology

- Press Work
- Drilling
- Metal Molding Electroforming
- Fine Casting
- Laser Processing

etc.



Power Device & Module

- Power Devices
- Power Modules
- Semiconductor Materials & Components
- Analysis Technologies
- Manufacturing & Testing Technologies
- EMC
- Heat Prevention (Heat Release & Cooling)
- Control/Drive/Sensing

etc.



Leading Companies Exhibit Every Year

<List of exhibitors in previous shows (excerpted)>

- AGC
- AJINOMOTO FINE-TECHNO
- ALMIT
- ALPS ALPINE
- AMADA MIYACHI
- ANALOG DEVICES
- ASE GROUP
- AT&S JAPAN
- BOSCH
- BROTHER INDUSTRIES
- CANON MACHINERY
- CARL ZEISS
- CKD
- CMK
- DAIICHI JITSUGYO
- DELTA ELECTRONICS (JAPAN)
- DENKA
- DUPONT
- EVERLIGHT ELECTRONICS
- FUJI
- FUJIPRINT
- FUJITSU ADVANCED TECHNOLOGIES

- FUJITSU INTERCONNECT TECHNOLOGIES
- HAKKO
- HAMAMATSU PHOTONICS
- HESSE MECHATRONICS JAPAN
- HITACHI HIGH-TECHNOLOGIES
- INFINEON TECHNOLOGIES JAPAN
- JAPAN AUTOMATIC MACHINE
- JAPAN UNIX
- JUTZE JAPAN
- KCE ELECTRONICS
- KEYENCE
- KODENSHI
- KOH YOUNG JAPAN
- KOKI
- KOMAX JAPAN
- KULICKE AND SOFFA (JAPAN)
- LAPIS SEMICONDUCTOR
- LPKF LASER & ELECTRONICS
- MEIKO ELECTRONICS
- MICRO-TEC
- MIRTEC JAPAN

- MITSUBISHI MATERIALS
- MURATA MANUFACTURING
- MYCRONIC TECHNOLOGIES
- NAGASE
- NAGOYA ELECTRIC WORKS
- NEWLONG SEIMITSU KOGYO
- NGK SPARK PLUG
- NIDEC
- NIPPON AVIONICS
- NIPPON CHEMI-CON
- NIPPON MEKTRON
- NORDSON ADVANCED TECHNOLOGY
- OKI ELECTRIC INDUSTRY
- OKI PRINTED CIRCUITS
- OLYMPUS
- OMRON
- ON SEMICONDUCTOR
- PANASONIC
- PARMi JAPAN
- REXXAM
- ROHM

- ROHM AND HAAS ELECTRONIC MATERIALS
- SAKI CORPORATION
- SCHLEUNIGER JAPAN
- SCREEN SEMICONDUCTOR SOLUTIONS
- SEKISUIPLASTICS
- SHIBUYA
- SHIMADZU
- SHIN-ETSU CHEMICAL
- SHINMAYWA INDUSTRIES
- SHOWA DENKO
- SONY SEMICONDUCTOR SOLUTIONS
- STANLEY ELECTRIC
- STMICROELECTRONICS
- TAIYO INK MFG.
- TAIYO YUDEN
- TAMURA
- TDK
- TEIJIN
- TEST RESEARCH (TRI)
- TOKYO ELECTRON DEVICE

- TOKYO WELD
- TORAY
- TOSHIBA ELECTRONIC DEVICES & STORAGE
- TRUMPF
- UBE INFORMATION SYSTEMS
- UENO SEIKI
- ULTRASONIC ENGINEERING
- USHIO
- WESTERN DIGITAL JAPAN
- XILINX
- YAC GARTER
- YAMAHA MOTOR
- YAMATO SCIENTIFIC

etc.

See here for full list of exhibitors in 2025 Tokyo Show -January-



Electronics Industry Gather Here!

<List of visitors in previous shows (excerpted)>

- AISIN
- ALPS ALPINE
- AMAZON
- AMD
- AMKOR TECHNOLOGY
- APPLE
- ASE
- ASUSTEK COMPUTER
- AUDI
- BMW
- BOE
- BOSCH
- BYD
- CANON
- CLARION
- COMPAL ELECTRONICS
- CONTINENTAL AUTOMOTIVE
- DAIMLER
- DELTA ELECTRONICS
- DENSO
- DENSO TEN
- EPISTER
- EVERLIGHT
- FAIRCHILD SEMICONDUCTOR
- FANUC
- FORD MOTOR
- FOXCONN
- FUJI FILM
- FUJITSU
- GE
- GENERAL MOTORS
- GOOGLE
- HAIER
- HISENSE
- HITACHI
- HITACHI AUTOMOTIVE SYSTEMS
- HONDA R&D
- HUAWEI TECHNOLOGIES
- HYUNDAI
- INFINEON TECHNOLOGIES JAPAN
- INTEL
- JDI
- KAWASAKI HEAVY INDUSTRIES
- KEIHIN
- KOITO MFG.
- KONICA MINOLTA
- KONKA
- KYOCERA
- LENOVO
- LG DISPLAY
- LG ELECTRONICS
- MAZDA MOTOR
- MEDIATEK
- MEGACHIPS
- MIDEA GROUP
- MITSUBISHI ELECTRIC
- MURATA MFG.
- NEC
- NICHIA
- NIHON KOHDEN
- NISSAN MOTOR
- NVIDIA
- OLYMPUS
- OMRON
- PANASONIC
- PEGATRON
- PIONEER
- PLEXUS
- QUALCOMM
- QUANTA COMPUTER
- RENAULT
- RENESAS ELECTRONICS
- ROHM
- SAMSUNG DISPLAY
- SAMSUNG ELECTRONICS
- SEIKO EPSON
- SHARP
- SHENZHEN CHINA STAR OPTOELECTRONICS TECHNOLOGY
- SIEMENS
- SK HYNIX
- SMIC
- SONY
- SPIL
- STANLEY ELECTRIC
- STMICROELECTRONICS
- SUZUKI MOTOR
- SYSEMEX
- TAIYO YUDEN
- TCL
- TDK
- TERUMO
- TOKAI RIKA
- TOSHIBA
- TOYOTA MOTOR
- TSMC
- VOLKSWAGEN
- VOLVO
- YAMAHA MOTOR
- YASKAWA

etc.

<Visitor profile>

Industry

 Semiconductor	 Electronic Device	 Automobile	 Wearable Device
 Medical	 Robot	 Machinery	 Aircraft/Aerospace

etc.

Job Division

<ul style="list-style-type: none"> • Manufacturing • Information System • Management • R&D • Maintenance • Production 	<ul style="list-style-type: none"> • Production Management • Planning • Purchase/Procurement • Construction • Quality Control • Plant/Facility Management 	<ul style="list-style-type: none"> • Development • Testing/Analysis
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etc.



Industry Leaders Support the Show

Sessions by industry leaders attract huge attention to visitors

<List of speakers in previous shows (excerpts)>



Norio Nakajima
President,
Murata Manufacturing Co., Ltd.



Atsuo Takemoto
Executive Officer, Manufacturing
and Procurement Headquarters
Konica Minolta, Inc.



Udo Welzel
Senior Expert, Automotive
Electronics – Engineering
Technology Integration,
Robert Bosch GmbH



Takeshi Inoue
Energy & Industry Group,
Power Device Application Dept.,
Application Engineer Div.,
ROHM Co., Ltd.



Takehiro Nakamura
Senior Vice President,
General Manager of 6G Labs.,
NTT DOCOMO, Inc.



Atsuto Shimada
Group General Manager,
Manufacturing Process Solution
Dept., Process Automation
Business Div., Connected
Solutions Company,
Panasonic Corp.



Daniel Isaacs
Director, Automotive,
Xilinx, Inc.



Rajneesh Kumar
Principal Engineer & Manager,
SIP & Module Packaging Tech.,
Qualcomm Inc.



Arihiro Kamiya
Semiconductor Strategy Planning
Dept., Electronics Platform Hardware
R&D Div.,
DENSO Corp.



Lee Jeongho
Products Development Team,
Project Leader,
(Principle Engineer),
Samsung Electronics Co., Ltd.



Terushi Shimizu
Senior Executive Vice President,
Sony Corp. /
Representative Director,
President and CEO,
Sony Semiconductor Solutions Corp.



Thorsten Meyer
Lead Principal, Package Concept
Engineering,
Infineon Technologies AG

Hot Topics Covered in the Previous Conferences

- **Chiplet & Advanced Packaging Technology**
- **Optical-electrical Integration**
- **Heterogeneous Integration Technology**
- **Next-gen. Power Devices**
- **Technology for AI & HPC**
etc.



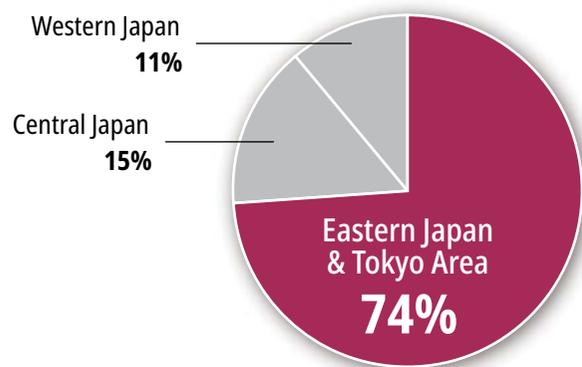
Honorifics omitted. In random order. Speakers' affiliations and positions are those at the time of the conference. Affiliations and positions may be omitted due to the space limit.

Held in **Tokyo** in February & September

◆ Meet Visitors from Tokyo & Eastern Japan!

Visitor Breakdown by Region

(Figures from Japanese Visitors in 2023 Tokyo Show)



<Companies located in Tokyo & Eastern Japan>

- NEC
- NISSAN MOTOR
- HONDA MOTOR
- HONDA R&D
- SUBARU
- HINO
- MITSUBISHI FUSO TRUCK & BUS
- TOYOTA MOTOR (Tokyo Office)
- MAZDA (Tokyo Office)
- ISUZU (Tokyo Office)
- SUZUKI (Tokyo Office)
- DAIHATSU (Tokyo Office)
- NIDEC (Tokyo Office)
- HITACHI ASTEMO
- ALPSALPINE
- KOITO MANUFACTURING
- NSK
- SONY
- STANLEY ELECTRIC
- AISIN (Tokyo Office)
- DENSO (Tokyo Office)
- NIDEC (Tokyo Office)
- PANASONIC (Tokyo Office)
- etc.

September Tokyo Show

380 Exhibitors & **28,000** Visitors

Dates: **September 9 (Wed) – 11 (Fri), 2026**

Venue: **Makuhari Messe, Japan**

- More than 90% of visitors only visit Sep. show! (Not to Jan. show)
- More focus on R&D
- Held with renewable energy exhibition

Concurrent Shows

5th RoboDEX (September)

5th SMART FACTORY Expo (September)

SMART ENERGY WEEK September 2026

2nd Manufacturing Industry's HR Expo (September)

4th GREEN FACTORY Expo (September)

5th AUTOMOTIVE WORLD (September)



February Tokyo Show

1,850 Exhibitors & **92,000** Visitors

Dates: **February 17 (Wed) – 19 (Fri), 2027**

Venue: **Tokyo Big Sight, Japan**

- World's Leading in Size
- Many Int'l Pavilions

Concurrent Shows

19th AUTOMOTIVE WORLD

Factory Innovation Week 2027



Numbers of exhibitors and visitors are forecasts including concurrent shows.

Held in **Nagoya** - Centre of manufacturing in Japan

◆ Meet Visitors from Central Japan

Aichi Prefecture has been ranked as No.1 in Manufacturing!

<Companies located in Central Japan>

- | | | |
|--|---|---------------------------------------|
| • TOYOTA (Aichi) | • Tokai Rika (Aichi) | • Nippon Sharyo (Aichi) |
| • DENSO (Aichi) | • Yazaki (Shizuoka) | • Mitsubishi Heavy Industries (Aichi) |
| • Aisin (Aichi) | • Aichi Machine Industry (Aichi) | • Nippon Kayaku (Niigata) |
| • Brother Industries (Aichi) | • Fujimi (Aichi) | • Kojima Press Industry (Fujichi) |
| • NGK Insulators (Aichi) | • Mitsubishi Electric (Aichi) | • Yamada Manufacturing (Nagano) |
| • Sumitomo Electric Industries (Aichi) | • Hitachi Automotive Systems (Shizuoka) | • Oiles (Aichi) |
- etc.

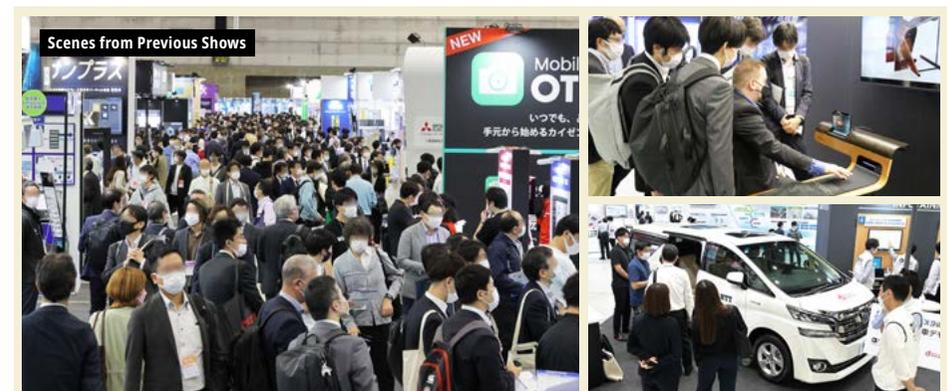


Nagoya
(Aichi Prefecture)

Dates: **November 25(Wed) – 27(Fri), 2026**
Venue: **AICHI SKY EXPO, Japan**

◆ 620 Exhibitors & 34,000 Visitors

Experience the SYNERGY! The visitors from other 6 co-held shows will visit your booth!



Numbers of exhibitors and visitors are forecasts including concurrent shows

Held in **Osaka** - Japan's Electronics Industry Cluster

◆ Meet Visitors from Western Japan

Held in Osaka, 2nd largest manufacturing area in Japan!
Osaka is known for its strong electronics industry.

<Companies located in Western Japan>

- | | | |
|--------------------------------|-----------------------------|-----------------------------------|
| • Panasonic (Osaka) | • NINTENDO (Kyoto) | (Kyoto) |
| • Sharp (Osaka) | • Daikin Industries (Osaka) | • Toshiba (Osaka) |
| • Kyocera (Kyoto) | • ROHM (Kyoto) | • Nichicon (Kyoto) |
| • Murata Manufacturing (Kyoto) | • Nidec (Kyoto) | • Sumitomo Wiring Systems (Osaka) |
| • Sumitomo Electric (Osaka) | • Dainippon Screen (Kyoto) | • Rinnai Corporation (Osaka) |
| • Omron (Kyoto) | • Sanyo Electric (Osaka) | • Kobelco (Kobe Steel) (Hyogo) |
| • Mitsubishi Electric (Hyogo) | • Fujitsu Ten (Hyogo) | |
| | • Shimadzu Corporation | |



Dates: **May 13(Wed) – 15(Fri), 2026**
Venue: **INTEX Osaka, Japan**

◆ 700 Exhibitors & 42,000 Visitors

Co-held with

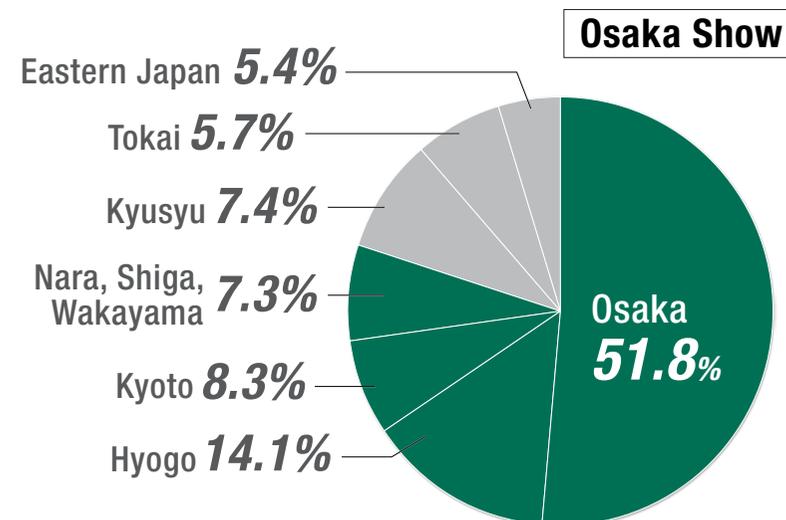
Factory Innovation Week OSAKA 2026 

<Visitors>

Engineers/Managements from departments of Production/
Manufacturing/Factory/Information System.....etc.

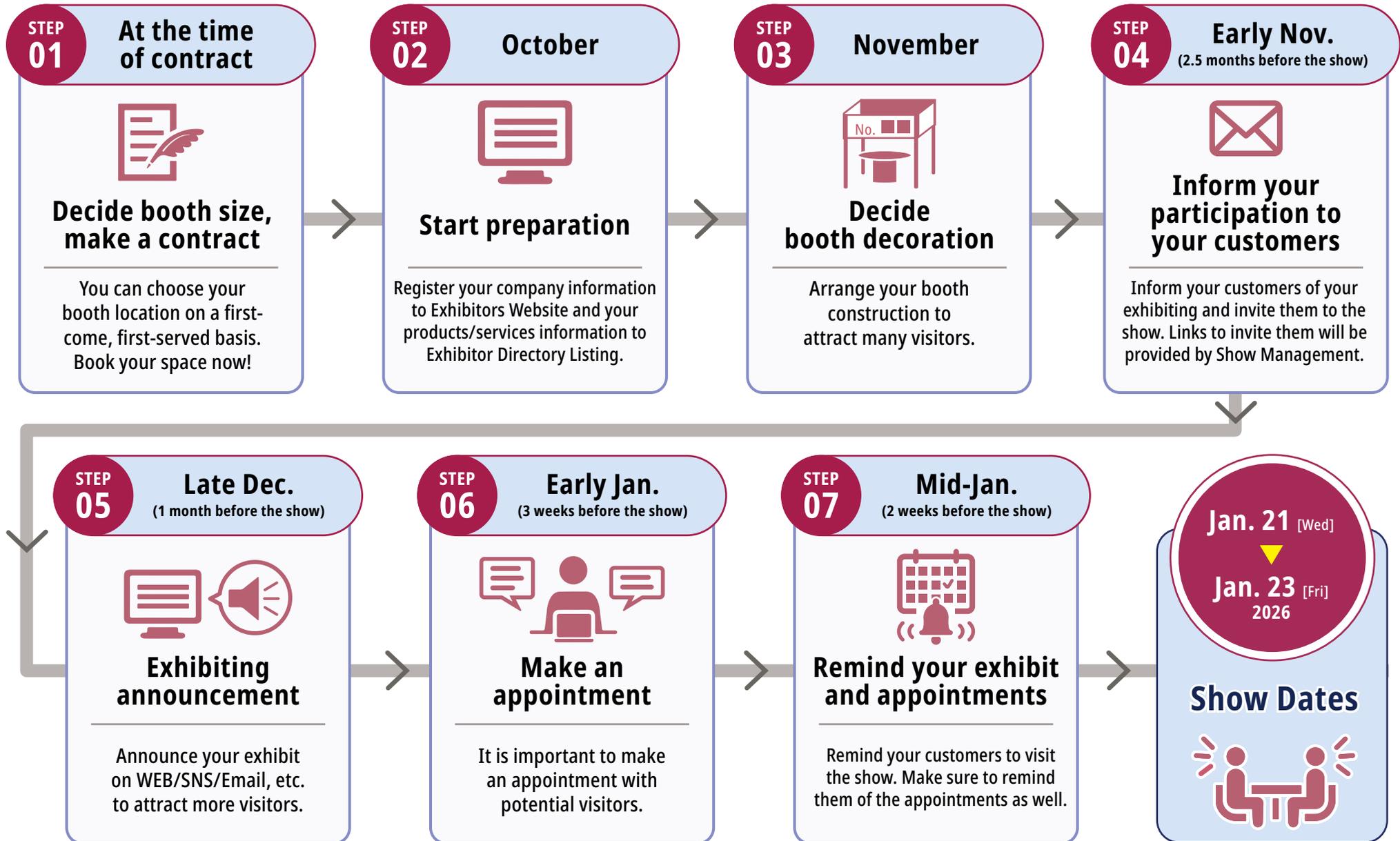
◆ Major visitors shall be from Western Japan

Visitors mainly gather from Western Japan



*The Chart data is from Manufacturing World Osaka show 2022
Visitor breakdown by region at another show (Manufacturing World Osaka 2022) which has also Tokyo, Nagoya and Osaka shows.

Schedule until the Show <Sample of Jan. Show Showcase>



How to Join as an Exhibitor

1

Please **contact Show Management** with your product information and your preferable exhibit space size.

2

Show Management will **offer available spaces** in the most suitable exhibit area for your products.

3

Please **choose your preferable location** and submit the space contract form.

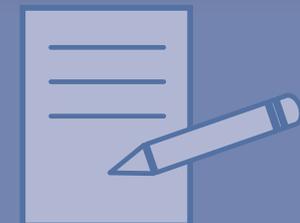
Please see below for the cost information and the Advertisement Opportunities.



Participation Cost



Advertisement Opportunities



Contract



**If you have any questions,
please feel free to contact us.**

► Contact

Organiser: RX Japan Ltd.

NEPCON JAPAN Show Management

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